



# BAT54QC

## Schottky barrier diode

27 November 2020

Product data sheet

## 1. General description

Planar Schottky barrier diode encapsulated in an ultra small DFN1412D-3 (SOT8009, JEDEC MO340-CA) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

## 2. Features and benefits

- Low forward voltage
- Low capacitance
- Leadless ultra small SMD plastic package
- Low package height of 0.5 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified

## 3. Applications

- Ultra high-speed switching
- Voltage clamping
- Protection circuits

## 4. Quick reference data

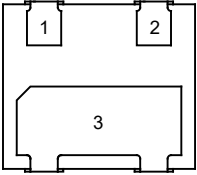
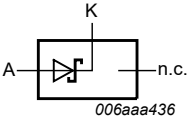
Table 1. Quick reference data

| Symbol | Parameter       | Conditions                                                            |     | Min | Typ | Max | Unit          |
|--------|-----------------|-----------------------------------------------------------------------|-----|-----|-----|-----|---------------|
| $V_R$  | reverse voltage |                                                                       |     | -   | -   | 30  | V             |
| $V_F$  | forward voltage | $I_F = 100 \text{ mA}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | -   | -   | 800 | mV            |
| $I_R$  | reverse current | $V_R = 25 \text{ V}$ ; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$   | [1] | -   | -   | 2   | $\mu\text{A}$ |

[1] Pulse test:  $t_p \leq 300 \text{ } \mu\text{s}$ ;  $\delta \leq 0.02$

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description   | Simplified outline                                                                                                               | Graphic symbol                                                                      |
|-----|--------|---------------|----------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| 1   | A      | anode         |  <p>Bottom view</p> <p>DFN1412D-3 (SOT8009)</p> |  |
| 2   | n.c.   | not connected |                                                                                                                                  |                                                                                     |
| 3   | K      | cathode       |                                                                                                                                  |                                                                                     |

6. Ordering information

Table 3. Ordering information

| Type number | Package    |                                                                                                                                                   |         |
|-------------|------------|---------------------------------------------------------------------------------------------------------------------------------------------------|---------|
|             | Name       | Description                                                                                                                                       | Version |
| BAT54QC     | DFN1412D-3 | plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.8 mm pitch; 1.4 mm x 1.2 mm x 0.48 mm body | SOT8009 |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| BAT54QC     | 9B           |

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter                           | Conditions                                                                                 |     | Min | Max | Unit               |
|-----------|-------------------------------------|--------------------------------------------------------------------------------------------|-----|-----|-----|--------------------|
| $V_R$     | reverse voltage                     |                                                                                            |     | -   | 30  | V                  |
| $I_F$     | forward current                     | $T_{amb} \leq 25\text{ }^{\circ}\text{C}$                                                  |     | -   | 200 | mA                 |
| $I_{FRM}$ | repetitive peak forward current     | $t_p \leq 1\text{ s}$ ; $\delta \leq 0.5$ ; $T_{amb} = 25\text{ }^{\circ}\text{C}$         |     | -   | 300 | mA                 |
| $I_{FSM}$ | non-repetitive peak forward current | square-wave pulse; $t_p \leq 10\text{ ms}$ ;<br>$T_{j(init)} = 25\text{ }^{\circ}\text{C}$ |     | -   | 600 | mA                 |
| $P_{tot}$ | total power dissipation             | $T_{amb} \leq 25\text{ }^{\circ}\text{C}$                                                  | [1] | -   | 415 | mW                 |
| $T_j$     | junction temperature                |                                                                                            |     | -   | 150 | $^{\circ}\text{C}$ |
| $T_{amb}$ | ambient temperature                 |                                                                                            |     | -55 | 150 | $^{\circ}\text{C}$ |
| $T_{stg}$ | storage temperature                 |                                                                                            |     | -65 | 150 | $^{\circ}\text{C}$ |

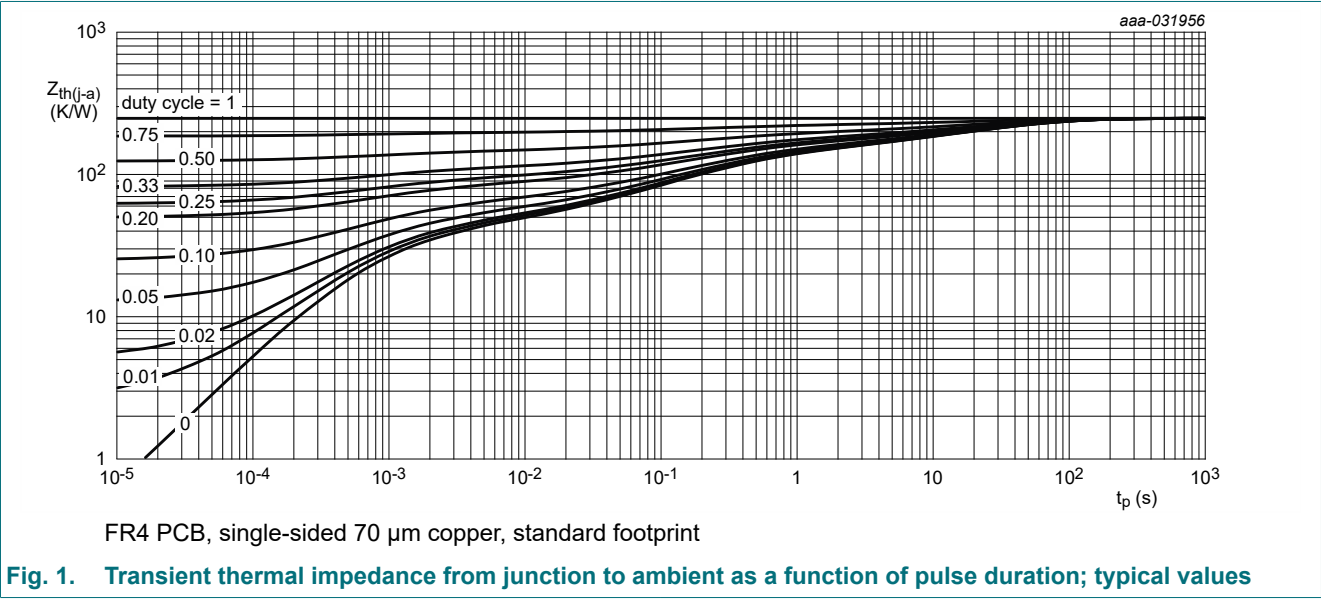
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70  $\mu\text{m}$  copper, tin-plated and standard footprint.

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol        | Parameter                                   | Conditions  |         | Min | Typ | Max | Unit |
|---------------|---------------------------------------------|-------------|---------|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] [2] | -   | -   | 290 | K/W  |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70  $\mu$ m copper, tin-plated and standard footprint.
- [2] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses PR are a significant part of the total power losses.

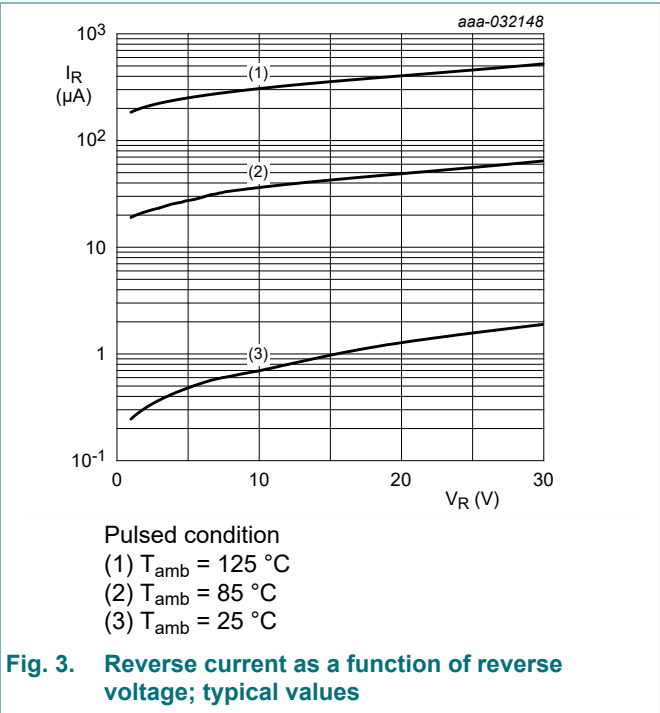
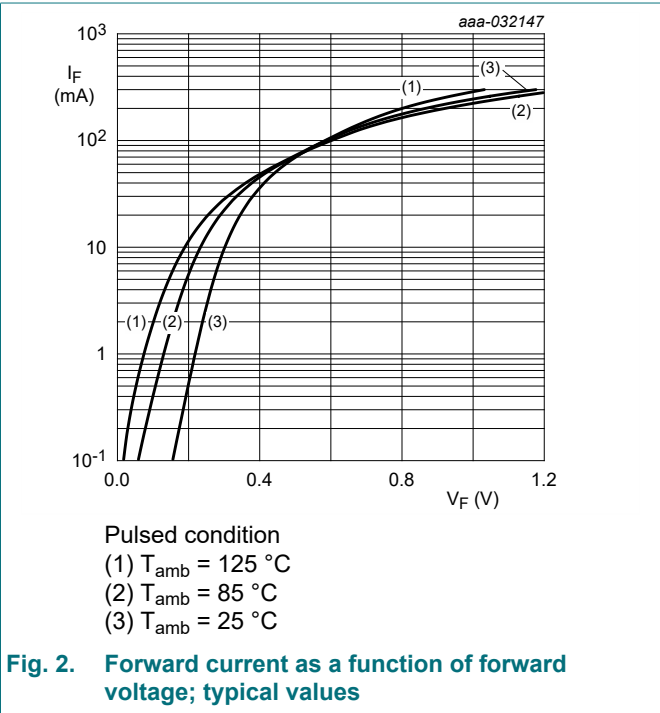


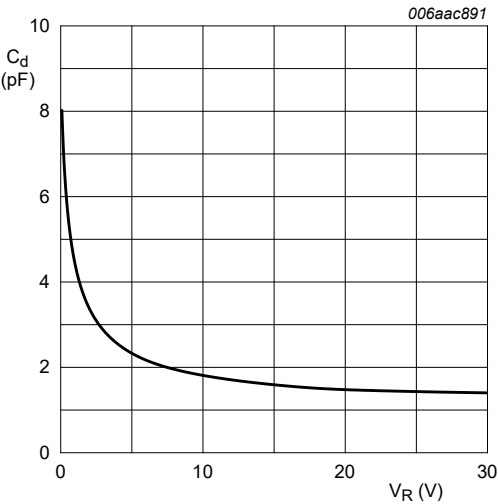
10. Characteristics

Table 7. Characteristics

| Symbol          | Parameter             | Conditions                                                                                                                       |     | Min | Typ | Max | Unit |
|-----------------|-----------------------|----------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-----|------|
| V <sub>F</sub>  | forward voltage       | I <sub>F</sub> = 0.1 mA; T <sub>amb</sub> = 25 °C                                                                                | [1] | -   | -   | 240 | mV   |
|                 |                       | I <sub>F</sub> = 1 mA; T <sub>amb</sub> = 25 °C                                                                                  | [1] | -   | -   | 320 | mV   |
|                 |                       | I <sub>F</sub> = 10 mA; T <sub>amb</sub> = 25 °C                                                                                 | [1] | -   | -   | 400 | mV   |
|                 |                       | I <sub>F</sub> = 30 mA; T <sub>amb</sub> = 25 °C                                                                                 | [1] | -   | -   | 500 | mV   |
|                 |                       | I <sub>F</sub> = 100 mA; T <sub>amb</sub> = 25 °C                                                                                | [1] | -   | -   | 800 | mV   |
| I <sub>R</sub>  | reverse current       | V <sub>R</sub> = 25 V; T <sub>amb</sub> = 25 °C                                                                                  | [1] | -   | -   | 2   | µA   |
| C <sub>d</sub>  | diode capacitance     | V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>amb</sub> = 25 °C                                                                        |     | -   | -   | 10  | pF   |
| t <sub>rr</sub> | reverse recovery time | I <sub>F</sub> = 10 mA; I <sub>R</sub> = 10 mA; R <sub>L</sub> = 100 Ω;<br>I <sub>R(meas)</sub> = 1 mA; T <sub>amb</sub> = 25 °C |     | -   | -   | 5   | ns   |

[1] Pulse test: t<sub>p</sub> ≤ 300 µs; δ ≤ 0.02

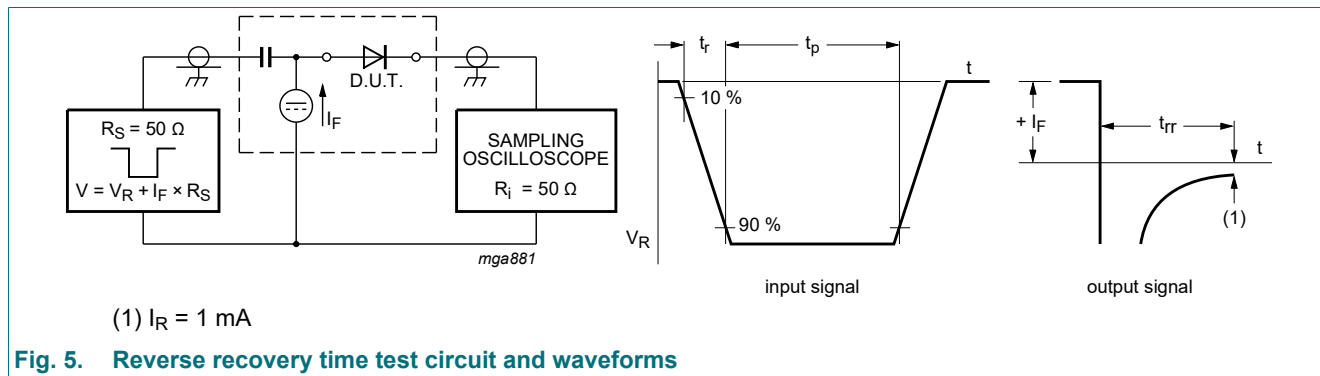




$T_{amb} = 25\text{ }^{\circ}\text{C}; f = 1\text{ MHz}$

Fig. 4. Diode capacitance as a function of reverse voltage; typical values

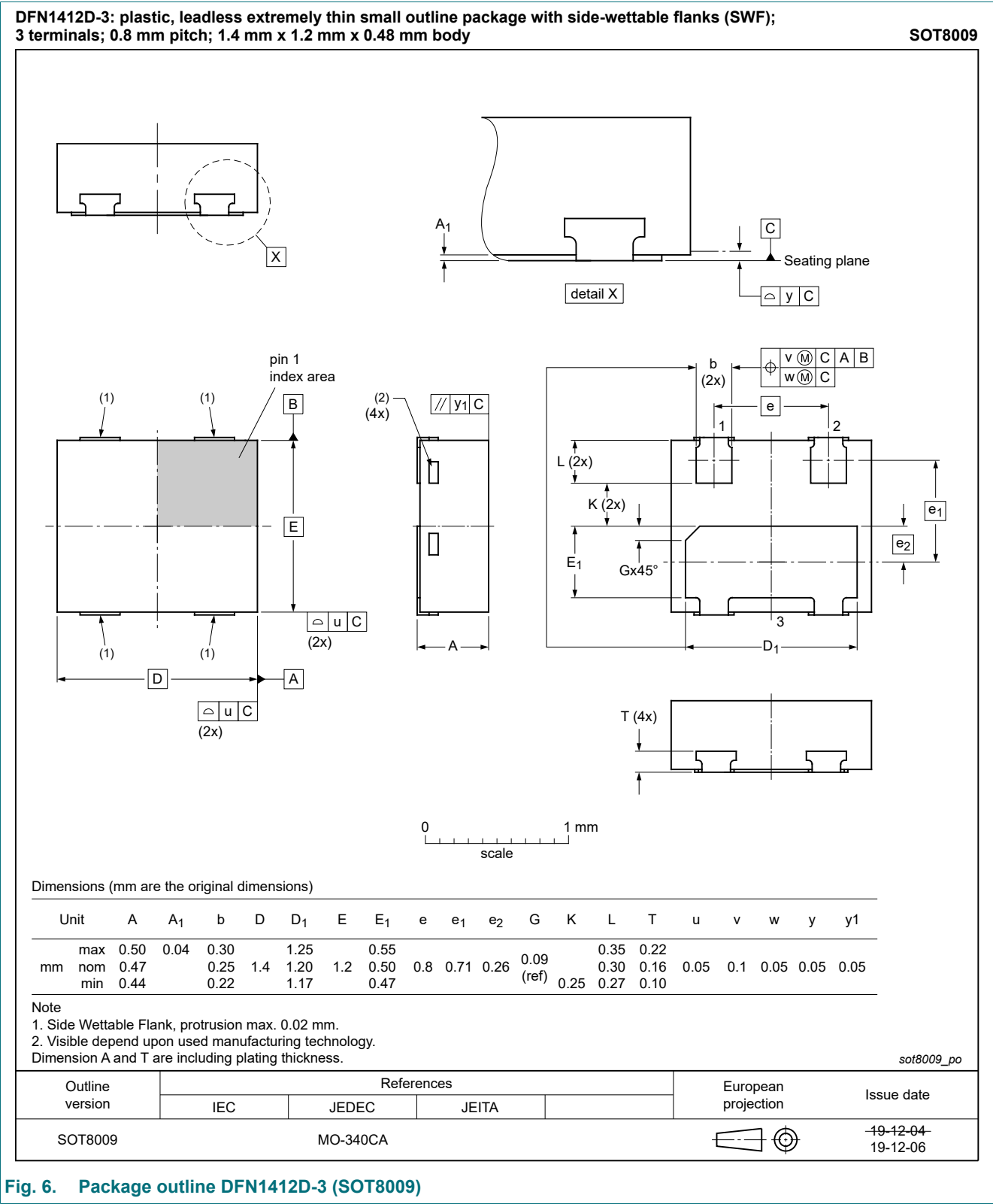
## 11. Test information



### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering

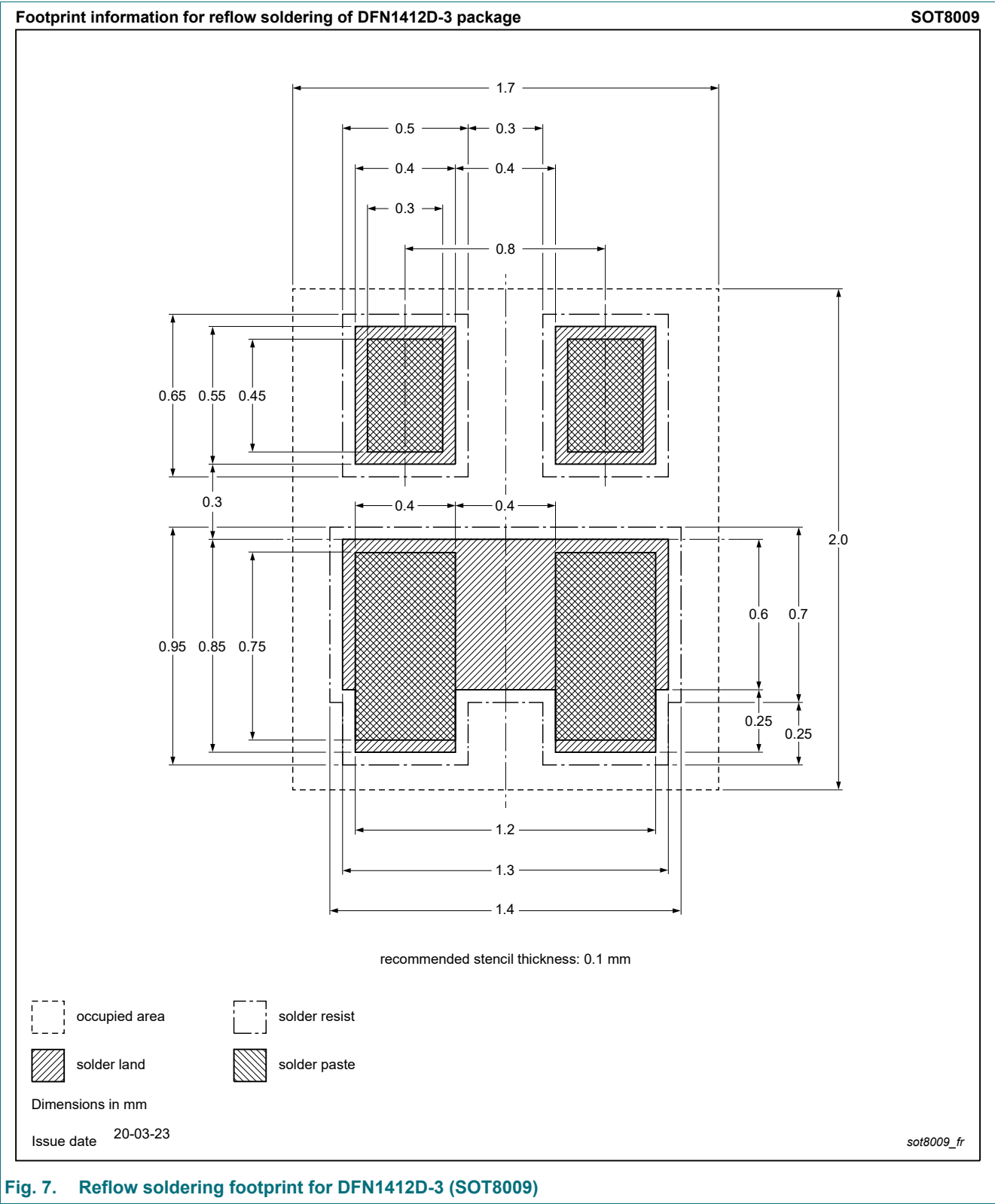


Fig. 7. Reflow soldering footprint for DFN1412D-3 (SOT8009)

## 14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status  | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| BAT54QC v.1   | 20201127     | Product data sheet | -             | -          |

## 15. Legal information

### Data sheet status

| Document status<br>[1][2]      | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

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